

### LM4980 Boomer® Audio Power Amplifier Series

# 2 Cell Battery, 1mA, 42mW Per Channel High Fidelity Stereo Headphone Audio Amplifier for MP3 players

#### **General Description**

The LM4980 is a stereo headphone audio amplifier, which when connected to a 3.0V supply, delivers 42mW to a  $16\Omega$  load with less than 1% THD+N. With the LM4980 packaged in the SD package, the customer benefits include low profile and small size. This package minimizes PCB area and maximizes output power.

The LM4980 features circuitry that significantly reduces output transients ("clicks" and "pops") while driving headphones during device turn-on and turn-off without costly external additional circuitry. The LM4980 also includes an externally controlled low-power consumption active-low shutdown mode, and thermal shutdown. Boomer audio power amplifiers are designed specifically to use few external components and provide high quality output power in a surface mount package.

### **Key Specifications**

■ Output power

 $(RL = 16\Omega, V_{DD} = 3.0V, THD+N = 1\%)$  42mW (typ)

■ Quiescent current (V<sub>DD</sub> = 3V) 1mA (typ)

■ Micropower shutdown current 0.1µA (typ)

■ Supply voltage operating range  $1.5V < V_{DD} < 3.3V$ 

■ PSRR @ 1kHz, V<sub>DD</sub> = 3.0V 90dB (typ)

■ PSRR @ 217Hz, V<sub>DD</sub> = 3.0V 100dB (typ)

#### **Features**

- 2-cell 1.5V to 3.3V battery operation
- Unity-gain stable
- "Click and pop" suppression circuitry for shutdown and power on/off transient with headphone loads
- Active low micro-power shutdown
- Thermal shutdown protection circuitry

#### **Applications**

- Portable two-cell audio products
- Portable two-cell electronic devices
- Portable MP3 player/recorders

### **Typical Application**

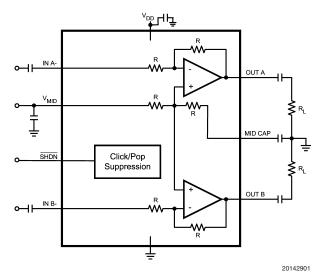
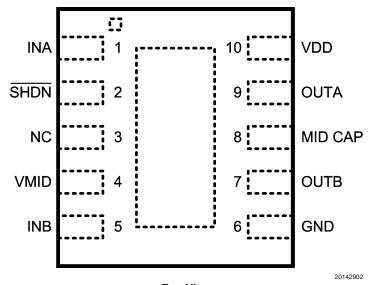


FIGURE 1. Block Diagram

Boomer® is a registered trademark of National Semiconductor Corporation.

# Connection Diagram 資间"LM4980SD"供应商

SD Package



Top View Order Number LM4980SD See NS Package Number SDA10A

### Typical Connection 查询"LM4980SD"供应商

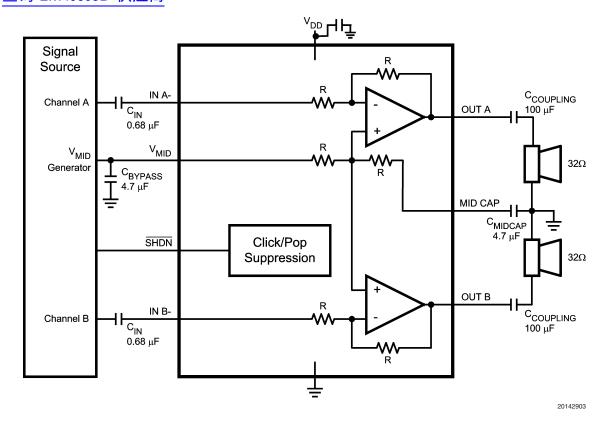


FIGURE 2. Typical Application Circuit

Absolute Maximum Ratings (Note 1) please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

> Supply Voltage 3.6V Storage Temperature -65°C to +150°C Input Voltage -0.3V to  $V_{DD} + 0.3V$ Power Dissipation (Note 2) Internally limited ESD Susceptibility(Note 3) 2000V

> ESD Susceptibility (Note 4) 200V Junction Temperature 150°C

Solder Information

Small Outline Package Vapor Phase (60sec) 215°C Infrared (15 sec)

See AN-450 "Surface Mounting and their Effects on Product Reliablilty" for other methods of soldering surface mount devices.

Thermal Resistance

 $\theta_{JA}$  (typ) SDA10A 73°C/W

220°C

### **Operating Ratings**

Temperature Range

 $-40^{\circ}C \leq T_{A} \leq +85^{\circ}C$  $T_{MIN} \le T_A \le T_{MAX}$  $1.5V \le V_{DD} \le 3.3V$ Supply Voltage

### Electrical Characteristics $V_{DD} = 3.0V$ (Notes 1, 5)

The following specifications apply for the circuit shown in Figure 2, unless otherwise specified.  $A_V = 0$ dB,  $R_L = 32\Omega$ . Limits apply for  $T_A = 25$ °C.

Symbol	Parameter	Conditions	LM4980		Units
			Typical	Limit	(Limits)
			(Note 6)	(Note 7)	
I <sub>DD</sub>	Quiescent Power Supply Current	$V_{IN} = 0V$ , $I_O = 0A$ , $R_L = \infty$ (Note 8)	1.0	1.5	mA (max)
I <sub>SD</sub>	Shutdown Current	V <sub>SHDN</sub> = GND	0.1	1	μΑ (max)
Vos	Output Offset Voltage		1	5	mV
Po	Output Power (Note 9)	$R_L = 16\Omega$ , THD+N = 1%, f = 1kHz, per channel	42	35	mW (min)
		$R_L = 32\Omega,$ THD+N = 1%, f = 1kHz, per channel	28		mW (min)
V <sub>NO</sub>	Output Voltage Noise	20Hz to 20kHz, A-weighted, Fig. 2	10		$\mu V_{RMS}$
THD+N	Total Harmonic Distortion + Noise	$R_L = 32\Omega$ , $P_{OUT} = 10$ mW, $f = 1$ kHz	0.02		%
Crosstalk		Freq = 1kHz, $P_{OUT}$ = 28mW, $R_L$ = 32 $\Omega$	77		dB
PSRR	Power Supply Rejection Ratio	$V_{\text{RIPPLE}} = 200 \text{mV}_{\text{P-P}}$ sine wave $f_{\text{RIPPLE}} = 1 \text{kHz}$ , $C_{\text{MIDCAP}} = 4.7 \mu\text{F}$ , $V_{\text{MID}}$ Voltage is Ripple-Free	90		dB
		$V_{RIPPLE} = 200 mV_{P-P}$ sine wave $f_{RIPPLE} = 217 Hz$ , $C_{MIDCAP} = 4.7 \mu F$ , $V_{MID}$ Voltage is Ripple-Free	100		dB
CMRR	Common-Mode Rejection Ratio	Input coupling capacitors with 5% tolerance, $V_{IN} = V_{MID}$ , $f_{RIPPLE} = 1 \text{kHz}$	47		dB
T <sub>WAKE-UP</sub>	Wake-up Time	$C_{\text{MIDCAP}} = 4.7 \mu\text{F}, \text{ Fig 2}.$	250		ms
V <sub>IH</sub>	Control Logic High	$1.5V \le V_{DD} \le 3.3V$		1.4V	V (min)
V <sub>IL</sub>	Control Logic Low	$1.5V \le V_{DD} \le 3.3V$		0.4V	V (max)

### Electrical Characteristics V<sub>DD</sub> = 1.8V (Notes 1, 5)

The following specifications apply for the circuit shown in Figure 2, unless otherwise specified.  $A_V = 0$ dB,  $R_L = 32\Omega$ . Limits apply for  $T_A = 25$ °C.

Symbol	Parameter	Conditions	LM4980		Units
			Typical	Limit	(Limits)
			(Note 6)	(Note 7)	
I <sub>DD</sub>	Quiescent Power Supply Current	$V_{IN} = 0V$ , $I_O = 0A$ , $R_L = \infty$ (Note 8)	0.9		mA
I <sub>SD</sub>	Shutdown Current	V <sub>SHDN</sub> = GND	0.1		μΑ
Vos	Output Offset Voltage		1		mV

Electrical Characteristics  $V_{DD}=1.8V$  (Notes 1, 5) (Continued) The complete the circuit shown in Figure 2, unless otherwise specified.  $A_V=0$  dB,  $R_L=32\Omega$ . Limits apply for  $T_A=25^{\circ}C$ .

Symbol	Parameter	Conditions	LM4980		Units
			Typical	Limit	(Limits)
			(Note 6)	(Note 7)	
P <sub>o</sub>	Output Power (Note 9)	$R_L = 16\Omega$ , THD+N = 1%, f = 1kHz, per channel	11		mW (min)
		$R_L = 32\Omega$ , THD+N = 1%, f = 1kHz, per channel	9		mW (min)
V <sub>NO</sub>	Output Voltage Noise	20Hz to 20kHz, A-weighted, Fig. 2	9		μV <sub>RMS</sub>
THD+N	Total Harmonic Distortion + Noise	$R_L = 32\Omega$ , $P_{OUT} = 10$ mW, $f = 1$ kHz	0.03		%
Crosstalk		Freq = 1kHz, $P_{OUT}$ = 9mW, $R_L$ = 32 $\Omega$	79		dB
PSRR	Power Supply Rejection Ratio	$V_{RIPPLE}$ = 200m $V_{P-P}$ sine wave $f_{RIPPLE}$ = 1kHz, $C_{MIDCAP}$ = 4.7 $\mu$ F, $V_{MID}$ Voltage is Ripple-Free	78		dB
		$V_{RIPPLE}$ = 200m $V_{P-P}$ sine wave $f_{RIPPLE}$ = 217Hz, $C_{MIDCAP}$ = 4.7 $\mu$ F, $V_{MID}$ Voltage is Ripple-Free	85		dB
CMRR	Common-Mode Rejection Ratio	Input coupling capacitors with 5% tolerance, $V_{IN} = V_{MID}$ , $f_{RIPPLE} = 1 \text{kHz}$	47		dB
T <sub>WAKE-UP</sub>	Wake-up Time	$C_{\text{MIDCAP}} = 4.7 \mu \text{F}, \text{ Fig 2}.$	320		ms
V <sub>IH</sub>	Control Logic High	$1.5V \le V_{DD} \le 3.3V$		1.4V	V (min)
V <sub>IL</sub>	Control Logic Low	$1.5V \le V_{DD} \le 3.3V$		0.4V	V (max)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

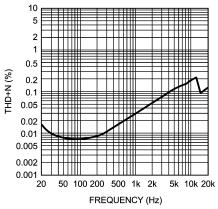
 $\textbf{Note 2:} \ \ \, \text{The maximum power dissipation is dictated by $T_{JMAX}$, $\theta_{JA}$, and the ambient temperature $T_{A}$ must be derated at elevated temperatures. The maximum $T_{A}$ is a constant of the same of the s$ allowable power dissipation is  $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$ . For the LM4980,  $T_{JMAX} = 150$  °C. For the  $\theta_{JA}$ s, please see the Application Information section or the Absolute Maximum Ratings section.

- Note 3: Human body model, 100pF discharged through a 1.5k $\Omega$  resistor.
- Note 4: Machine model, 200pF 220pF discharged through all pins.
- Note 5: All voltages are measured with respect to the ground (GND) pins unless otherwise specified.
- Note 6: Typicals are measured at 25°C and represent the parametric norm.
- Note 7: Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.
- Note 8: The quiescent power supply current depends on the offset voltage when a practical load is connected to the amplifier.
- Note 9: Output power is measured at the device terminals.

## Typical Performance Characteristics $(T_A = 25^{\circ}C)$

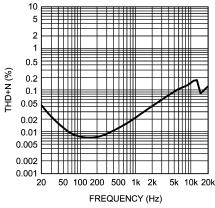
询"LM4980SD"供应商+N vs Frequency

$$V_{DD}$$
 = 1.8V,  $R_L$  = 32 $\Omega$ ,  $P_O$  = 7.3mW



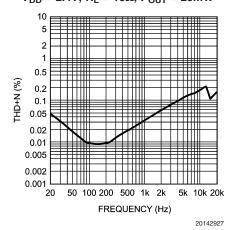
20142905

THD+N vs Frequency  $V_{DD}$  = 3V,  $R_L$  = 32 $\Omega$ ,  $P_{OUT}$  = 23mW

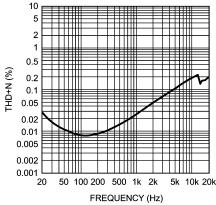


20142918

THD+N vs Frequency  $V_{DD} = 2.4V,\, R_L = 16\Omega,\, P_{OUT} = 20mW$ 

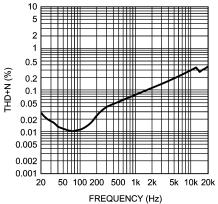


THD+N vs Frequency  $V_{DD}$  = 2.4V,  $R_L$  = 32 $\Omega$ ,  $P_{OUT}$  = 14mW



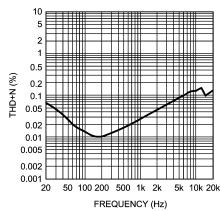
20142913

THD+N vs Frequency  $\label{eq:VDD} \text{V}_{\text{DD}} = \text{1.8V}, \, \text{R}_{\text{L}} = \text{16}\Omega, \, \text{P}_{\text{OUT}} = \text{9.3mW}$ 



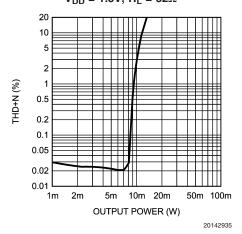
20142922

THD+N vs Frequency  $\label{eq:VDD} V_{DD} = 3V, \ R_L = 16\Omega, \ P_{OUT} = 27mW$ 

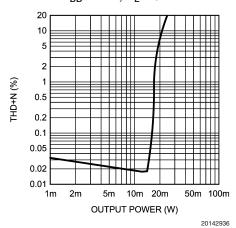


## Typical Performance Characteristics (T<sub>A</sub> = 25°C) (Continued) 查询"LM4980SD"供应商

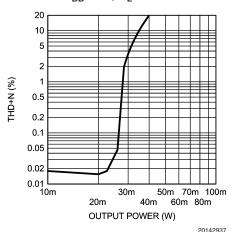
#### THD+N vs Output Power $V_{DD} = 1.8V, R_{L} = 32\Omega$



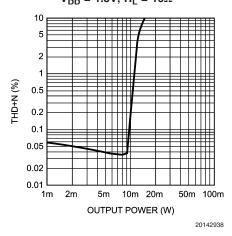
#### THD+N vs Output Power $V_{DD} = 2.4V, R_{L} = 32\Omega$



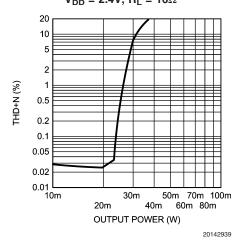
#### THD+N vs Output Power $V_{DD}$ = 3V, $R_L$ = 32 $\Omega$



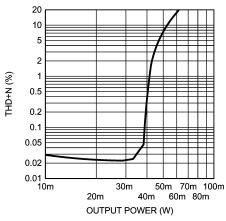
THD+N vs Output Power  $V_{DD}$  = 1.8V,  $R_L$  = 16 $\Omega$ 



THD+N vs Output Power  $V_{DD} = 2.4V, R_{L} = 16\Omega$ 

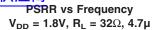


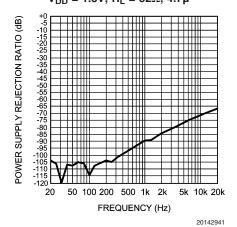
THD+N vs Output Power  $V_{DD} = 3V$ ,  $R_L = 16\Omega$ 



## Typical Performance Characteristics (T<sub>A</sub> = 25°C) (Continued)

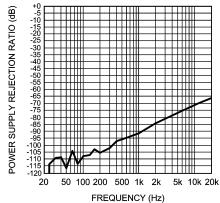
询"LM4980SD"供应商





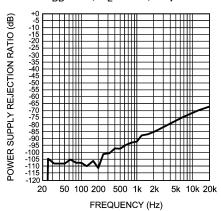
 $V_{DD} = 2.4V, R_L = 32\Omega, 4.7\mu$ 

**PSRR vs Frequency** 



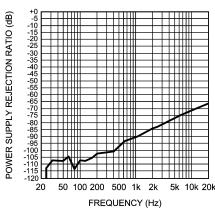
20142942

PSRR vs Frequency  $V_{DD} = 3V$ ,  $R_L = 32\Omega$ ,  $4.7\mu$ 



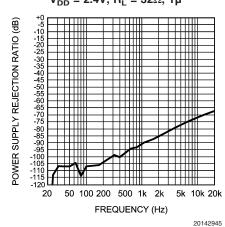
20142943

PSRR vs Frequency  $V_{DD}$  = 1.8V,  $R_L$  = 32 $\Omega$ , 1 $\mu$ 

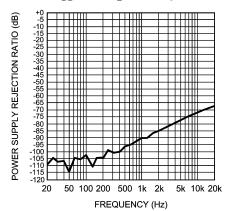


20142944

## PSRR vs Frequency $V_{DD}$ = 2.4V, $R_L$ = 32 $\Omega$ , 1 $\mu$



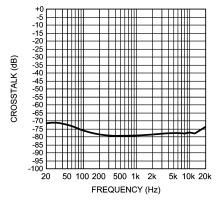
PSRR vs Frequency  $V_{DD}$  = 3V,  $R_L$  = 32 $\Omega$ , 1 $\mu$ 



20142946

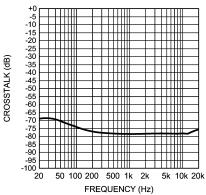
## Typical Performance Characteristics (T<sub>A</sub> = 25°C) (Continued) 查询"LM4980SD"供应商

Crosstalk vs Frequency  $V_{DD}$  = 1.8V,  $R_L$  = 32 $\Omega$ ,  $P_{OUT}$  = 9mW Channel A Driven, Channel B Measured



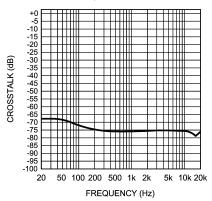
20142947

Crosstalk vs Frequency  $V_{DD}$  = 2.4V,  $R_L$  = 32 $\Omega$ ,  $P_{OUT}$  = 17mW Channel A Driven, Channel B Measured



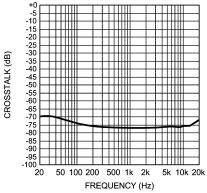
20142950

Crosstalk vs Frequency  $V_{DD} = 3V$ ,  $R_L = 32\Omega$ ,  $P_{OUT} = 27mW$ Channel A Driven, Channel B Measured



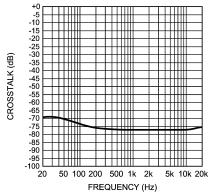
20142951

Crosstalk vs Frequency  $V_{DD}$  = 1.8V,  $R_L$  = 32 $\Omega$ , $P_{OUT}$  = 9mW Channel B Driven, Channel A Measured



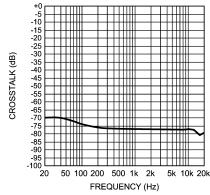
20142948

Crosstalk vs Frequency  $V_{DD}$  = 2.4V,  $R_L$  = 32 $\Omega$ ,  $P_{OUT}$  = 17mW Channel B Driven, Channel A Measured



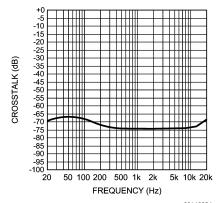
20142949

Crosstalk vs Frequency  $V_{DD}$  = 3V,  $R_L$  = 32 $\Omega$ ,  $P_{OUT}$  = 27mW Channel B Driven, Channel A Measured



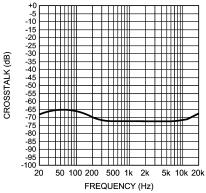
# Typical Performance Characteristics (T<sub>A</sub> = 25°C) (Continued) 询"LM4980SD"供应商

Crosstalk vs Frequency  $V_{DD}$  = 1.8V,  $R_L$  = 16 $\Omega$ ,  $P_{OUT}$  = 11mW Channel A Driven, Channel B Measured



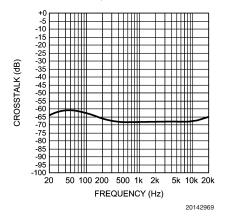
20142954

Crosstalk vs Frequency  $V_{DD}$  = 2.4V,  $R_L$  = 16 $\Omega$ ,  $P_{OUT}$  = 24mW Channel A Driven, Channel B Measured

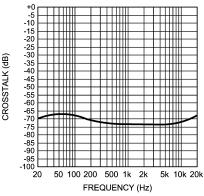


20142960

Crosstalk vs Frequency  $V_{DD}$  = 3V,  $R_L$  = 16 $\Omega$ ,  $P_{OUT}$  = 42mW Channel A Driven, Channel B Measured

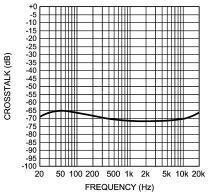


Crosstalk vs Frequency  $V_{DD}$  = 1.8V,  $R_L$  = 16 $\Omega$ ,  $P_{OUT}$  = 11mW Channel B Driven, Channel A Measured



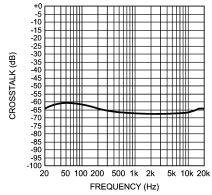
20142956

Crosstalk vs Frequency  $V_{DD}$  = 2.4V,  $R_L$  = 16 $\Omega$ ,  $P_{OUT}$  = 24mW Channel B Driven, Channel A Measured



20142968

Crosstalk vs Frequency  $\mathrm{V_{DD}=3V,\,R_{L}=16\Omega,\,P_{OUT}=42mW}$ Channel B Driven, Channel A Measured

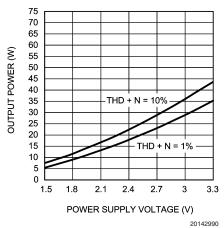


20142970

## Typical Performance Characteristics (T<sub>A</sub> = 25°C) (Continued) 查询"LM4980SD"供应商

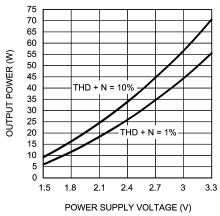
### Output Power vs Supply Voltage

 $R_L = 32\Omega$ 



## **Output Power vs Supply Voltage**

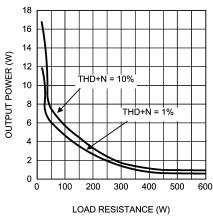
 $R_L = 16\Omega$ 



20142991

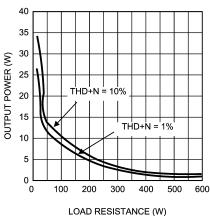
## **Output Power vs Load Resistance**

 $V_{\rm DD} = 1.8V$ 



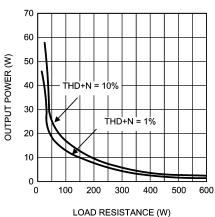
## **Output Power vs Load Resistance**

 $V_{\rm DD} = 2.4 V$ 

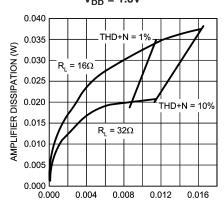


20142975

**Output Power vs Load Resistance**  $V_{DD} = 3.0V$ 



Load Dissipation vs Amplifier Dissipation  $V_{DD} = 1.8V$ 

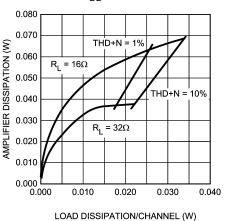


LOAD DISSIPATION/CHANNEL (W)

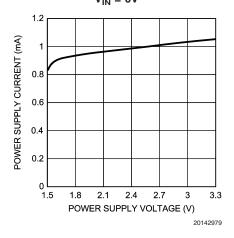
20142976

## Typical Performance Characteristics (T<sub>A</sub> = 25°C) (Continued) 询"LM4980SD"供应商

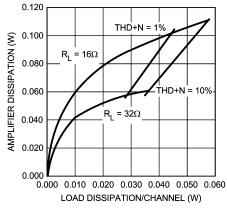
**Amplifier Dissipation vs Load Dissipation**  $V_{DD} = 2.4V$ 



## Power Supply Current vs Power Supply Voltage



#### **Amplifier Dissipation vs Load Dissipation** $V_{\rm DD} = 3.0 V$



20142978

#### **Application Information**

查询"LM4980SD"供应商 AMPLIFIER CONFIGURATION

As shown in Figure 1, the LM4980 consists of a stereo pair of audio amplifiers. These amplifiers operate on a single supply and have single-ended inputs and outputs. The quiescent operating point of each amplifier input and output is equal to the voltage applied to the  $V_{\rm MID}$  pin (usually  $V_{\rm DD}/2$ ).

#### **C<sub>MIDCAP</sub> VALUE SELECTION**

Careful consideration should be paid to value of  $C_{\text{MIDCAP}}$ , the capacitor connected between the MIDCAP pin and ground. The value of  $C_{\mbox{\scriptsize MIDCAP}}$  determines how fast the LM4980 settles to quiescent operation and determines the amount of output transient suppression. Choosing C<sub>MIDCAP</sub> equal to  $4.7\mu F$  along with a small value of  $C_{\text{IN}}$  (in the range of  $0.1\mu F$  to  $1.0\mu F)$ , produces shutdown function that is essentially output-transient free. Choosing  $\mathbf{C}_{\text{IN}}$  no larger than necessary for the desired bandwidth helps minimize clicks and pops. This ensures that output transients are minimized when power is first applied or the LM4980 resumes operation after shutdown. The MIDCAP offers the following benefits: better linearity for reduced THD+N, reduced channelto-channel crosstalk, and less susceptibility to ground noise. For the ultimate suppression of output transient when power is applied or removed, ensure that the voltage applied to the SHDN pin is a logic low. This will activate the micro-power shutdown.

#### **OPTIMIZING OUTPUT-GROUND NOISE REDUCTION**

In addition to the output-ground noise reduction afforded by  $C_{\text{MIDCAP}},$  further reduction can be achieved by the inclusion of a ferrite bead. The ferrite bead (FB) is placed between ground and common connection between the  $C_{\text{MIDCAP}}$  and the headphone ground connection. This is shown in Figure 3. The ferrite bead is beneficial in environments where the headphone and  $C_{\text{MIDCAP}}$  ground connection is shared with circuitry (such as video) that may inject noise on a common ground.

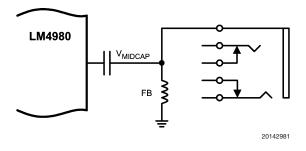


FIGURE 3. Adding a ferrite bead improves ground-noise suppression

#### **OPTIMIZING OUTPUT TRANSIENT SUPPRESSION**

The LM4980 contains circuitry that eliminates turn-on and shutdown output transients ("clicks and pops"). For this discussion, turn-on refers to either applying the power supply voltage or when the micro-power shutdown mode is deactivated. The turn-on time delay is the time duration that occurs between the application of the power supply voltage or deactivating shutdown and when the applied input signal appears at the amplifier outputs.

 $C_{\text{MIDCAP}}$ 's value plays a significant role in the suppression of output transients. The amount of suppression increases as

 $C_{\text{MIDCAP}}$ 's value increases. However, changing the value of  $C_{\text{MIDCAP}}$  alters the LM4980's turn-on time. There is a linear relationship between the value of  $C_{\text{MIDCAP}}$  and the turn-on time. Here are some typical turn-on times for various values of  $C_{\text{MIDCAP}}.$ 

TABLE 1. Typical turn-on time versus C<sub>MIDCAP</sub> value

C <sub>MIDCAP</sub> VALUE (µF)	Turn-On Time (ms)
4.7	250
6.8	360
10.0	530

#### STAND-ALONE $V_{\mbox{\scriptsize MID}}$ VOLTAGE GENERATION

The LM4980 is designed to take advantage of audio DACs (digital-to-analog converters) and other signal sources that, in addition to generating an analog signal, also create an AC ground potential. This AC ground potential is typically  $V_{\rm DD}/2$ . This  $V_{\rm DD}/2$  is applied to the LM4980's  $V_{\rm MID}$  pin (pin 4).

Using two external resistors allows the LM4980 to be easily used in applications where the  $V_{\text{MID}}$  voltage is not internally generated and supplied to the LM4980 by other circuits. Figure 4 shows this configuration.

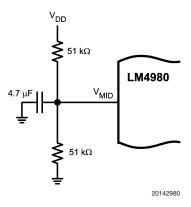


FIGURE 4. Simple circuit generates LM4980's V<sub>MID</sub> voltage

## SELECTING THE OUTPUT COUPLING CAPACITOR VALUE

To ensure that no performance degrading DC current flows through the load (something with which speakers would just as soon not have to tolerate), coupling capacitors are necessary between the amplifier output pins and the load. Besides blocking DC current, the output coupling capacitor value, together with the load resistance, produces a low frequency amplitude rolloff, whose cutoff frequency is found using Equation 1.

$$f_{-3 dB} = \frac{1}{2\pi R_{LOAD} C_{COUPLING}}$$
 (1)

When driving 32 $\Omega$  headphones, the 220 $\mu$ F C<sub>COUPLING</sub> capacitors shown in Figure 2 produce a cutoff frequency equal to 23Hz.

The output coupling capacitors also influence the output transient behavior at power-up and when activating or deac-

Application Information (Continued)

[Application Information (Continued)]

[Application Information (Continued)]

[Application Information (Continued)]

[Application Information (Continued)] mitigated by a corresponding increase in C<sub>MIDCAP</sub>'s value. A minimum starting point when selecting C<sub>MIDCAP</sub>'s value is 6.8µF when using 220µF output coupling capacitors.

#### SELECTING THE INPUT CAPACITOR VALUE

Amplifying the lowest audio frequencies requires a relatively high value input coupling capacitor, (CIN in Figure 2). A high value capacitor can be expensive and may compromise space efficiency in portable designs. In many cases, however, the headphones used in portable systems have limited ability to reproduce signals below 60Hz. Applications using headphones with this limited frequency response reap little improvement by using a high value input capacitor. A small value of Ci (in the range of 0.1μF to 1.0μF), is recommended.

#### **DRIVING POWERED SPEAKERS**

Though the LM4980 is design primarily to drive headphones, in many cases, it may be called on to act as a line level driver when powered speakers or other devices may be connected to the amplifier outputs. For powered speakers or other devices with typical input resistances (10k $\Omega$ ) that are significantly higher than the typical headphone resistance (32 $\Omega$ ), the output transients may not sufficiently suppressed when using the Figure 2 circuit. If this is anticipated, a minor modification of an additional resistor (a nominal value of  $1k\Omega$ ) between each output and ground in the Figure 2 circuit is needed to ensure that the output transient suppression is not compromised. This reduces both the load resistance seen by the LM4980 and the magnitude of power-on and shutdown output transients.

#### POWER DISSIPATION

Power dissipation has to be evaluated and considered when designing a successful amplifier. A direct consequence of the power delivered to a load an amplifier is internal power dissipation. The maximum per-amplifier power dissipation for a given application can be derived from the power dissipation graphs or from Equation 2.

$$PDMAX = V_{DD}^2 / 2\pi R_{LOAD}$$
 (2)

It is critical that the maximum junction temperature T<sub>JMAX</sub> of 150°C is not exceeded. Since the typical application is for headphone operation (16 $\Omega$  impedance) using a 3.0V supply the maximum power dissipation is less than 29mW. Therefore, in the case of this headphone amplifier, the power dissipation is not a major concern.

#### POWER SUPPLY BYPASSING

As with any amplifier, proper supply bypassing is important for low noise performance and high power supply rejection. The capacitor location on the power supply pins should be as close to the device as possible. Typical applications employ a 3.0V regulator with 10µF tantalum or electrolytic capacitor and a ceramic bypass capacitor which aid in supply stability. This does not eliminate the need for local power supply bypassing connected as close as possible to the LM4980's supply pin. A power supply bypass capacitor value in the range of 1.0µF to 10µF is recommended.

#### MICRO POWER SHUTDOWN

The voltage applied to the shutdown (SHDN) pin controls the LM4980's shutdown function. Activate micro-power shutdown by applying a logic-low voltage to the SHDN pin. When active, the LM4980's micro-power shutdown feature turns off the amplifier's bias circuitry, reducing the supply current. The trigger point is 0.4V (max) for a logic-low level, and 1.4V (min) for a logic-high level. The low 0.1µA (typ) shutdown current is achieved by applying a voltage that is as near as ground as possible to the SHDN pin. A voltage that is higher than ground may increase the shutdown current.

There are a few ways to control the micro-power shutdown. These include using a single-pole, single-throw switch, a microprocessor, or a microcontroller. When using a switch, connect an external  $100k\Omega$  pull-up resistor between the SHDN pin and GND. Connect the switch between the SHDN pin and V<sub>DD</sub>. Select normal amplifier operation by closing the switch. Opening the switch connects the SHDN pin to ground, activating micro-power shutdown. The switch and resistor guarantee that the SHDN pin will not float. This prevents unwanted state changes. In a system with a microprocessor or microcontroller, use a digital output to apply the control voltage to the SHDN pin. Driving the SHDN pin with active circuitry eliminates the pull-up resistor.

#### SUGGESTED PCB SCHEMATIC

Figure 5 is the schematic for the suggested PCB Layout. This schematic and its associated PCB provide both a lean tested layout and platform that can be used to verify the LM4980's outstanding audio performance.

#### Suggested PCB Design and Layout

Figures 6 through 9 show a suggested PCB layout for a headphone amplifier circuit using the LM4980.

#### **PCB Layout Guidelines**

This section provides practical guidelines for mixed signal PCB layout that involves various digital/analog power and ground traces. Designers should note that these are only "rule-of-thumb" recommendations and the actual results will depend heavily on the final layout.

#### MINIMIZING THD+N

PCB trace impedance on the power, ground, and all output traces should be minimized to achieve optimal THD performance. Therefore, use PCB traces that are as wide as possible for these connections. As the gain of the amplifier is increased, the trace impedance will have an ever increasing adverse affect on THD performance. At unity-gain (0dB) the parasitic trace impedance effect on THD performance is reduced but still a negative factor in the THD performance of the LM4980 in a given application.

#### **GENERAL MIXED SIGNAL LAYOUT** RECOMMENDATION

#### **Power and Ground Circuits**

For two layer mixed signal design, it is important to isolate the digital power and ground trace paths from the analog power and ground trace paths. Star trace routing techniques (bringing individual traces back to a central point rather than daisy chaining traces together in a serial manner) can greatly enhance low level signal performance. Star trace

Application Information (Continued)
rounding in M4980SD"供应商aces to feed power and ground to each circuit or even device. This technique will require a greater amount of design time but will not increase the final price of the board. The only extra parts required may be some jumpers.

#### **Single-Point Power and Ground Connections**

The analog power traces should be connected to the digital traces through a single point (link). A "PI-filter" can be helpful in minimizing high frequency noise coupling between the analog and digital sections. Further, place digital and analog power traces over the corresponding digital and analog ground traces to minimize noise coupling.

#### **Placement of Digital and Analog Components**

All digital components and high-speed digital signal traces should be located as far away as possible from analog components and circuit traces.

#### **Avoiding Typical Design / Layout Problems**

Avoid ground loops or running digital and analog traces parallel to each other (side-by-side) on the same PCB layer. When traces must cross over each other do it at 90 degrees. Running digital and analog traces at 90 degrees to each other from the top to the bottom side as much as possible will minimize capacitive noise coupling and cross talk.

## Suggested PCB Layout 查询"LM4980SD"供应<u>商</u>

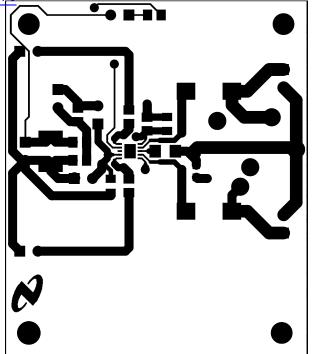


FIGURE 6. Top Layer

20142982

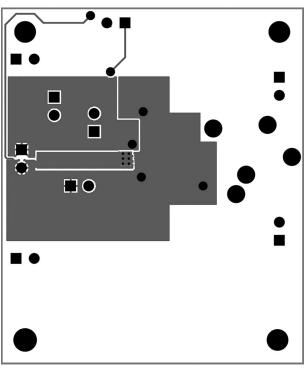


FIGURE 7. Bottom Layer

# Suggested PCB Layout (Continued) 查询"LM4980SD"供应商

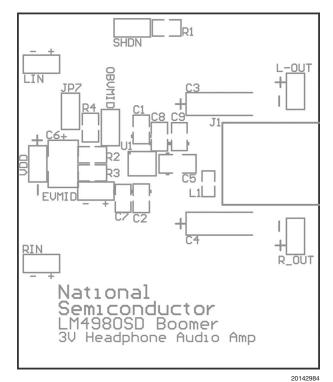


FIGURE 8. Silkscreen Layer

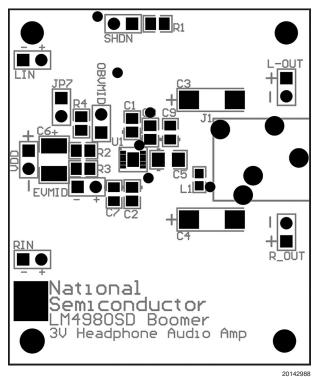


FIGURE 9. Top Layer Pads

## **Revision History**

Rev	Date	<del>80SD"供应商</del> Description		
1.0	6/08/05	Initial release.		
1.1	6/29/05	Correct typographical and schematic errors.		
		Re-released D/S to the WEB.		
1.2	7/18/05	Replaced curves 20142971 and 72 with 20142990 and 91 respectively, then re-released D/S to the WEB.		

### avers Physical Dimensions inches (millimeters) unless otherwise noted 旬"LM4980SD"供应商 DIMENSIONS ARE IN MILLIMETERS MENSIONS IN () FOR REFERENCE ON (10X 0 6) (0.1) (10X 0.25) RECOMMENDED LAND PATTERN \_\_\_C (45° X0.25) PIN 1 INDEX AREA PIN 1 п 0 0.4±0.1 В 10X 0.25±0.05 ⊕ 0.1M C AS BS 8X 0.5 SDA10A (Rev A) **SD Package** Order Number LM4980SD **NS Package Number SDA10A**

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.

For the most current product information visit us at www.national.com.

#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT AND GENERAL COUNSEL OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### **BANNED SUBSTANCE COMPLIANCE**

National Semiconductor manufactures products and uses packing materials that meet the provisions of the Customer Products Stewardship Specification (CSP-9-111C2) and the Banned Substances and Materials of Interest Specification (CSP-9-111S2) and contain no "Banned Substances" as defined in CSP-9-111S2.

Leadfree products are RoHS compliant.



National Semiconductor Americas Customer Support Center

Email: new.feedback@nsc.com Tel: 1-800-272-9959

www.national.com

National Semiconductor Europe Customer Support Center Fax: +49 (0) 180-530 85 86

Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 69 9508 6208
English Tel: +44 (0) 870 24 0 2171
Français Tel: +33 (0) 1 41 91 8790

National Semiconductor Asia Pacific Customer Support Center Email: ap.support@nsc.com National Semiconductor Japan Customer Support Center Fax: 81-3-5639-7507 Email: jpn.feedback@nsc.com Tel: 81-3-5639-7560